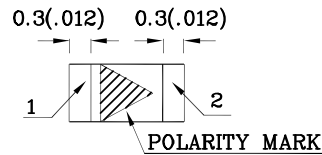
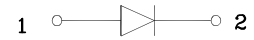
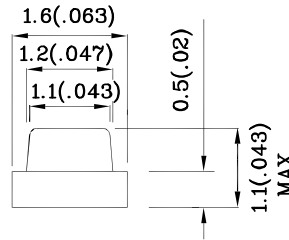
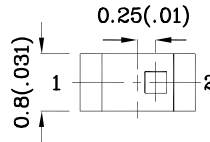


Features

- 1.6mmx0.8mm SMT LED, 1.1mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

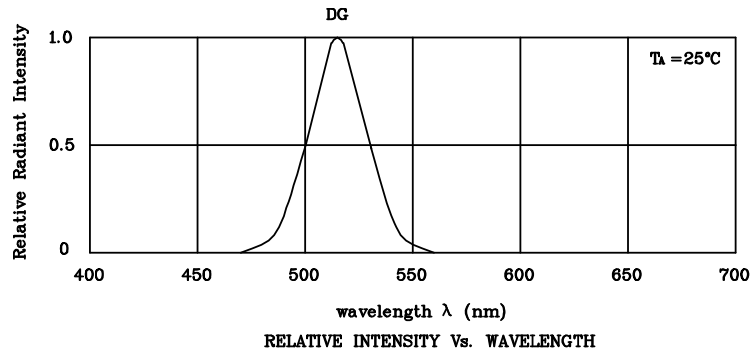
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ " unless otherwise noted.
3. Specifications are subject to change without notice.

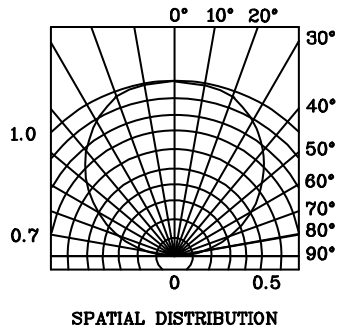
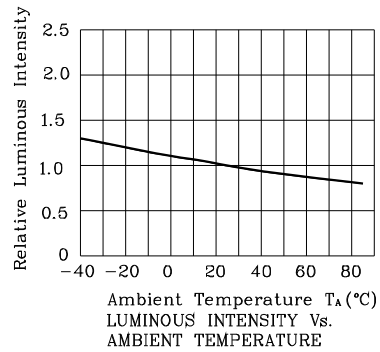
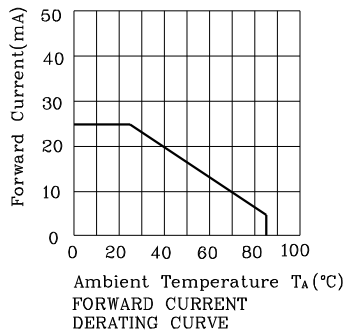
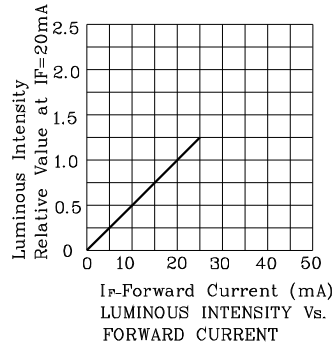
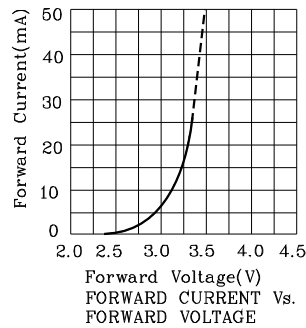
Absolute Maximum Ratings (TA=25°C)		DG (InGaN)	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	150	mA
Power Dissipation	P _D	102.5	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	

Operating Characteristics (TA=25°C)		DG (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V _F	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V _F	4.1	V
Reverse Current (Max.) (V _R =5V)	I _R	50	uA
Wavelength Of Peak Emission (Typ.) (I _F =20mA)	λ P	515	nm
Wavelength Of Domi- nant Emission (Typ.) (I _F =20mA)	λ D	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XZDG53W	Green	InGaN	Water Clear	280	447	515	120°

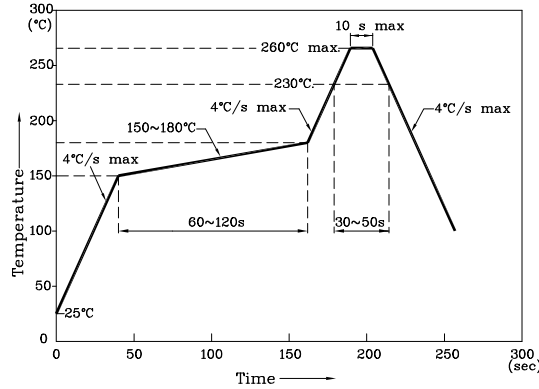


❖ DG



**Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.**

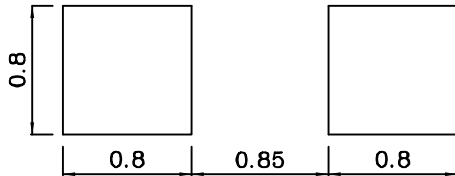
Reflow Soldering Profile For Lead-free SMT Process.



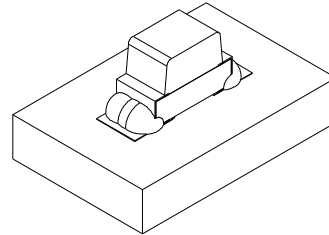
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C-260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

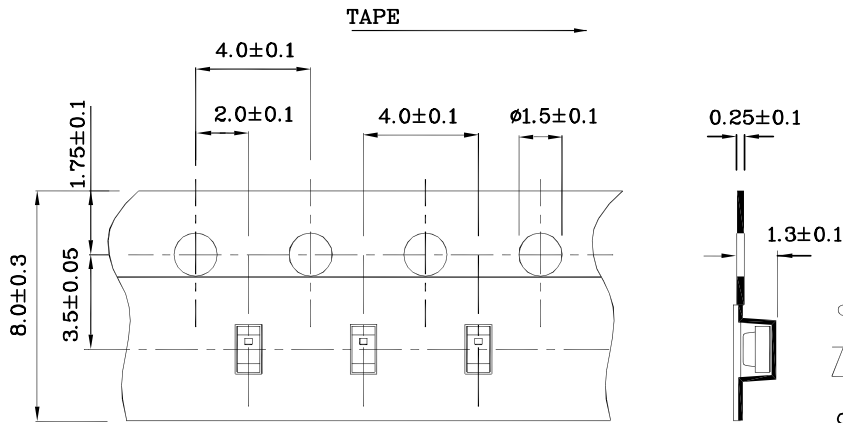
❖ **Recommended Soldering Pattern**
(Units : mm; Tolerance: ± 0.1)



❖ **The device has a single mounting surface. The device must be mounted according to the specifications.**



❖ **Tape Specification (Units : mm)**



Remarks:

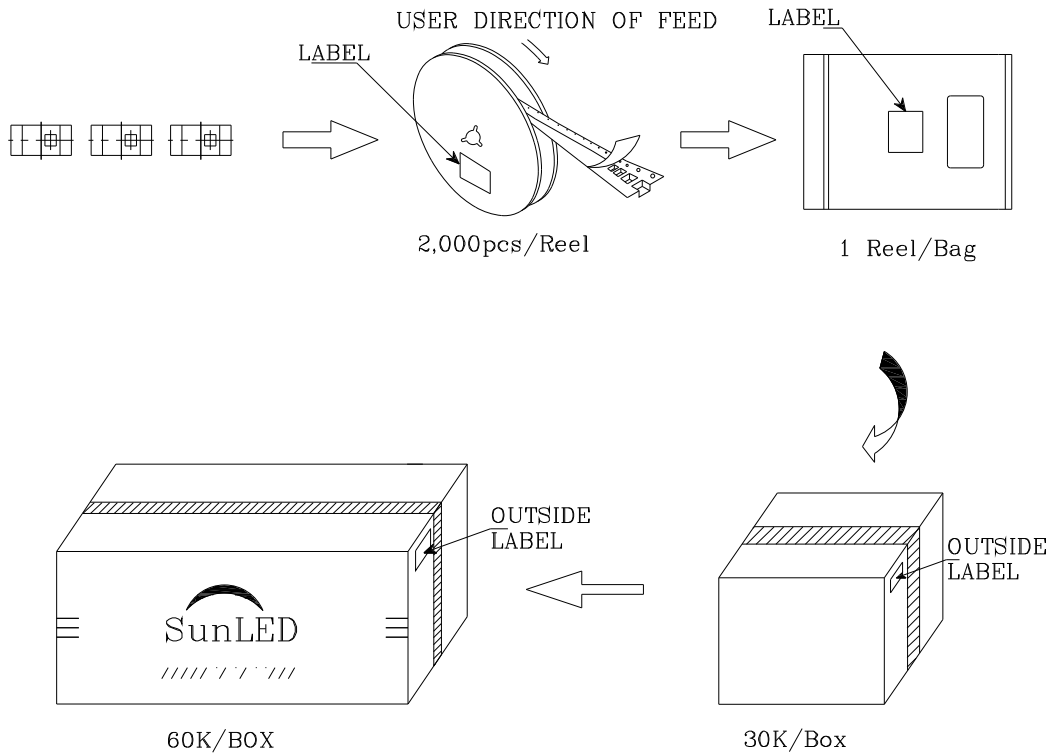

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS


XZDG53W

Q.C. Q C

XX XX. XXXX

PASSED

P/NO : XZxxx53x	
QTY : 2,000 pcs	CODE: XXX
S/N : XX	
LOT NO :	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	